Amendments to the Claims:

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

- 1. (Currently amended) A method for checking optical proximity correction data, the method comprising:
 - (a) dividing a chip region into at least first and second regions;
 - (b) selecting the first region from the divided regions;
- (c) providing a first layout database of an integrated circuit design <u>corresponding</u> to the first region, wherein the first layout database is obtained before optical proximity correction treatment;
- (d) providing a second layout database of the integrated circuit design corresponding to the first region, wherein the second database is obtained after optical proximity correction treatment;
 - (e) finding a location of a first structure in the first layout database;
- (f) simulating a resulting layout output for the first structure using the second layout database;
- (g) measuring a first critical dimension of the first structure from the resulting layout output for the first structure;
- (h) comparing the first critical dimension of the first structure to a drawn dimension of the first structure from the first database; and
- (i) flagging the first structure in the second database if the first critical dimension is less than the first drawn dimension of the first database;
- (j) repeating the steps (a) to (i) to generate a defect report at least on the first and second regions;
 - (k) analyzing the defect report to identify one or more problematic patterns; and
 - (1) identifying unique patterns from the one or more problematic patterns.

- 2. (Currently amended) The method of claim 1 wherein the step of flagging the first structure in the second database if the first dimension is less than the first drawn dimension in the first database-the step (i) is replaced by flagging the first structure in the second database if the first dimension is less than the first drawn dimension plus a tolerance value in the first database.
- 3. (Currently amended) The method of claim 2 wherein the tolerance value is defined by a user.
- 4. (Original) The method of claim 1 wherein the first and second layout databases in GDSII format.
- 5. (Original) The method of claim 1 wherein the first structure is at least one of a transistor gate, transistor end-cap line, line-end, via and gap, or contact and gap.
- 6. (Original) The method of claim 1 wherein the step of finding a location of a first structure in the first layout database is performed using pattern recognition.
- 7. (Original) The method of claim 1 wherein when the first structure is a transistor gate, the first critical dimension is a gate length.
- 8. (Original) The method of claim 1 wherein the first structure is a transistor gate, the first critical dimension is a gate width.

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- 9. (Currently amended) The method of claim 1 further comprising:

 (m) building a model of a process, to be used to fabricated the integrated circuit design, and wherein the step of simulating a resulting layout output for the first structure using he the second layout database is performed using this model of the process.
- 10. (Original) The method of claim 1 wherein the step of simulating a resulting layout output for the first structure using the second layout database comprises consulting a look-up table.

11-13. (Canceled)

- 14. (Original) The method of claim 13 wherein the tolerance value is specified by a user.
- 15. (Currently amended) A method for generating a circuit design, the method comprising:

providing a first layout database of an integrated circuit design, wherein the first layout database is obtained before optical proximity correction treatment;

providing a second layout database of the integrated circuit design, wherein the second database is obtained after optical proximity correction treatment;

finding a location of a first structure in the first layout database;

finding a first structure in the second layout database based on its location in the first layout database;

simulating a resulting layout output for the first structure using the second layout database;

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measuring a first critical dimension of the first structure from the resulting layout output for the first structure;

comparing the first critical dimension of the first structure to a drawn dimension of the first structure from the first database; and

flagging the first structure in the first database if the first critical dimension is less than the first drawn dimension in the first database to generate a defect report;

analyzing the defect report to identify one or more problematic patterns; and identifying unique patterns from the one or more problematic patterns.

16. (Original) The method of claim 15 further comprising:

flagging the first structure in the second database if the first critical dimension is less than the first drawn dimension in the first database.